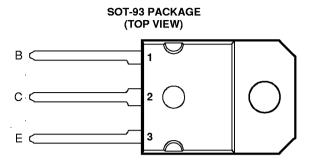
- **Designed for Complementary Use with** TIP140, TIP141 and TIP142
- 125 W at 25°C Case Temperature
- 10 A Continuous Collector Current
- Minimum h_{FE} of 1000 at 4 V, 5 A



Pin 2 is in electrical contact with the mounting base

MDTRAA

absolute maximum ratings at 25°C case temperature (unless otherwise noted)

RATING			VALUE	UNIT	
	TIP145		-60		
Collector-base voltage (I _E = 0)	TIP146	V _{CBO}	-80	v	
	TIP147		-100		
	TIP145		-60		
Collector-emitter voltage (I _B = 0)	TIP146	V _{CEO}	-80	V	
	TIP147		-100		
Emitter-base voltage			-5	٧	
Continuous collector current			-10	Α	
Peak collector current (see Note 1)			-15	Α	
Continuous base current			-0.5	Α	
Continuous device dissipation at (or below) 25°C case temperature (see Note 2)			125	w	
Continuous device dissipation at (or below) 25°C free air temperature (see Note 3)			3.5	W	
Unclamped inductive load energy (see Note 4)			100	mJ	
Operating junction temperature range			-65 to +150	°C	
Storage temperature range			-65 to +150	°C	
Lead temperature 3.2 mm from case for 10 seconds			260	°C	

- NOTES: 1. This value applies for $t_p \le 0.3$ ms, duty cycle $\le 10\%$.

 2. Derate linearly to 150°C case temperature at the rate of 1 W/°C.
 - 3. Derate linearly to 150°C free air temperature at the rate of 28 mW/°C.
 - 4. This rating is based on the capability of the transistor to operate safely in a circuit of: L = 20 mH, I_{B(on)} = -5 mA, R_{BE} = 100 Ω, $V_{BE(off)} = 0$, $R_S = 0.1 \Omega$, $V_{CC} = -20 V$.

TIP145, TIP146, TIP147 PNP SILICON POWER DARLINGTONS

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electrical characteristics at 25°C case temperature

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V _{(BR)CEC}	Collector-emitter breakdown voltage	I _C = -30 mA	I _B = 0	TIP145 TIP146	-60 -80			٧
		(see Note 5)		TIP147	-100			
	cut-off current	V _{CE} = -30 V	I _B = 0	TIP145			-2	
I _{CEO}		$V_{CE} = -40 \text{ V}$	$I_B = 0$	TIP146			-2	mA
		$V_{CE} = -50 \text{ V}$	$I_B = 0$	TIP147			-2	
	Collector cut-off current	V _{CB} = -60 V	$I_E = 0$	TIP145			-1	
I _{CBO}		$V_{CB} = -80 \text{ V}$	$I_E = 0$	TIP146			-1	mΑ
		V _{CB} = -100 V	I _E = 0	TIP147			-1	
I _{EBO}	Emitter cut-off current	V _{EB} = -5 V	I _C = 0				-2	mA
L	Forward current	V _{CE} = -4 V	I _C = -5 A	/ N. 5 10)	1000			
h _{FE}	transfer ratio	$V_{CE} = -4 \text{ V}$ $I_C = -10 \text{ A}$ (see Notes 5 and	(see Notes 5 and 6)	500				
V	Collector-emitter	I _B = -10 mA	I _C = -5 A	(see Notes 5 and 6)			-2	V
V _{CE(sat)}	saturation voltage	I _B = -40 mA	$I_{\rm C} = -10 \text{ A}$				-3	٧
V _{BE}	Base-emitter	V _{CE} = -4 V	I _C = -10 A	(see Notes 5 and 6)			-3	V
	voltage						J	٧
V _{EC}	Parallel diode forward voltage	I _E = -10 A	I _B = 0	(see Notes 5 and 6)			-3.5	٧

NOTES: 5. These parameters must be measured using pulse techniques, $t_p = 300 \,\mu s$, duty cycle $\leq 2\%$.

resistive-load-switching characteristics at 25°C case temperature

	PARAMETER	TEST CONDITIONS †			MIN	TYP	MAX	UNIT
t _{on}	Turn-on time	I _C = -10 A	I _{B(on)} = -40 mA	$I_{B(off)} = 40 \text{ mA}$		0.9		μs
t _{off}	Turn-off time	$V_{BE(off)} = 4.2 V$	$R_L = 3 \Omega$	$t_p = 20 \ \mu s, \ dc \le 2\%$		11		μs

 $^{^{\}dagger}$ Voltage and current values shown are nominal; exact values vary slightly with transistor parameters.

^{6.} These parameters must be measured using voltage-sensing contacts, separate from the current carrying contacts.

TYPICAL CHARACTERISTICS

TYPICAL DC CURRENT GAIN vs **COLLECTOR CURRENT** TCS145AA 10000 -40°C T_c = 25°C _c = 100°C h_{FE} - Typical DC Current Gain 1000 -4 V = = 300 μs, duty cycle < 2% 100 -0.5 -1.0 -10 -20 Ic - Collector Current - A

Figure 1.

COLLECTOR-EMITTER SATURATION VOLTAGE

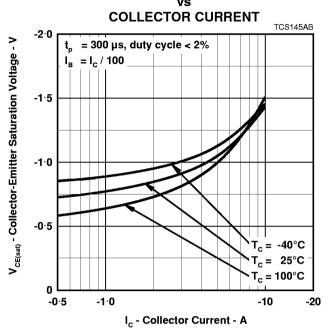
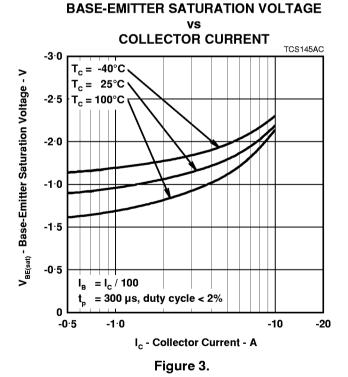
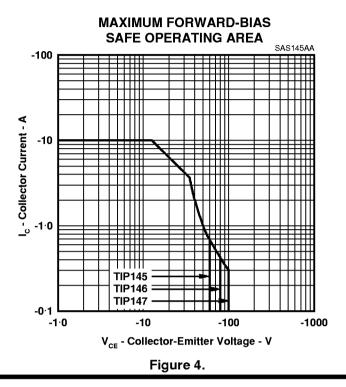


Figure 2.



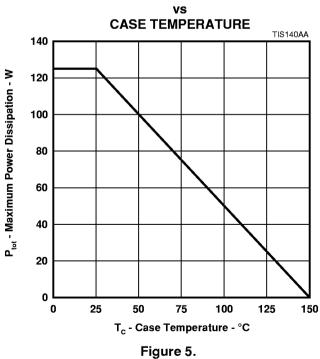
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THERMAL INFORMATION

MAXIMUM POWER DISSIPATION



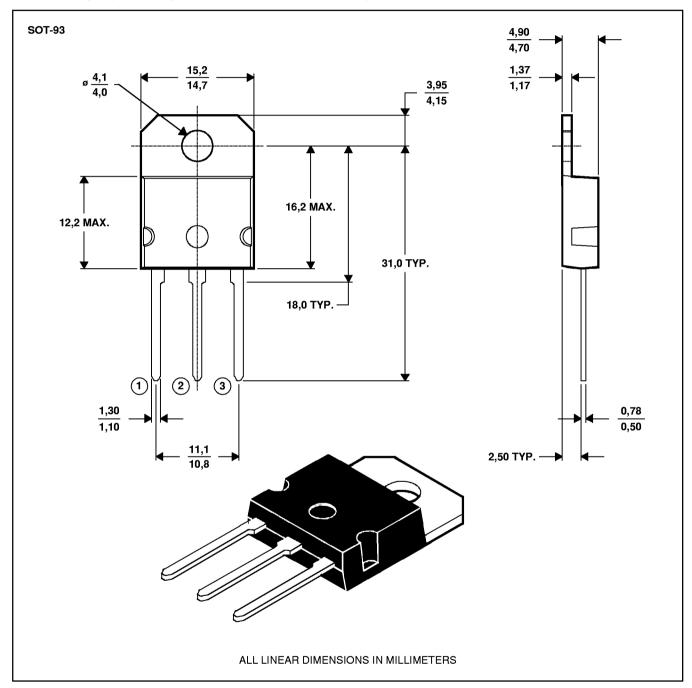
PRODUCT INFORMATION

MECHANICAL DATA

SOT-93

3-pin plastic flange-mount package

This single-in-line package consists of a circuit mounted on a lead frame and encapsulated within a plastic compound. The compound will withstand soldering temperature with no deformation, and circuit performance characteristics will remain stable when operated in high humidity conditions. Leads require no additional cleaning or processing when used in soldered assembly.



NOTE A: The centre pin is in electrical contact with the mounting tab.

MDXXAW

PRODUCT INFORMATION

TIP145, TIP146, TIP147 PNP SILICON POWER DARLINGTONS

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